

PRODUCT DATA SHEET

Sikafloor®-161 HC

2-PART EPOXY PRIMER, LEVELLING MORTAR, INTERMEDIATE LAYER AND MORTAR SCREED

DESCRIPTION

Sikafloor®-161 HC is an economic, two part, solvent free, low viscosity epoxy resin.

USES

Sikafloor®-161 HC may only be used by experienced professionals.

- For priming concrete substrate, cement screeds and epoxy mortars
- For low to medium absorbent substrates
- Primer for Sikafloor®-263 SL HC and Sikafloor®-264 HC economic flooring systems
- Binder for levelling mortars and mortar screeds
- Intermediate layer underneath Sikafloor®-263 SL HC and Sikafloor®-264 HC

CHARACTERISTICS / ADVANTAGES

- Low viscosity
- Good penetration
- Excellent bond strength
- Solvent free
- Easy application
- Short waiting times
- Multi-purpose

PRODUCT INFORMATION

Composition	Ероху				
Packaging	20 kg set	Part A	15.8	3 kg	
		Part B	4.2	kg	
	Drums	Part A	280	kg	
		Part B	200	kg	
Appearance / Colour	Part A – Resin Liquid, brow		Liquid, brownish	vnish-transparent	
	Part B – Hardener	•	Liquid, transpare	ent	
Shelf Life	24 months from date of production if stored properly in original, unopened and undamaged sealed packaging				
Storage Conditions	Store in dry condi	tions at tempera	tures between +18 '	°C and +30 °C.	
Density	Part A	~1.6 k	:g/l	(DIN EN ISO 2811-1)	
	Part B	~1.0 k	g/l	at +23 °C	
	Mixed resin	~1.4 k	g/l	_	
Solid content by weight	~100 %				

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Shore D Hardness	7 days (at +23 °C)	~76	(DIN 53 505)
Compressive Strength	28 days (at +23 °C)	~60 N/mm² (resin)	(EN 196-1)
Tensile Strength in Flexure	28 days (at +23 °C)	~30 N/mm² (resin)	(EN 196-1)
Tensile Adhesion Strength	> 1.5 N/mm² (failure in concrete)		(ISO 4624)
Chemical Resistance	Resistant to many chemicals. Please ask for a detailed chemical resistance table.		
Temperature Resistance	Exposure*	Dry Heat	
•	Permanent	+50 °C	
	Short-term max. 7 d	+80 °C	
	Short-term max. 12 h +100 °C		
	Short-term moist/wet heat* up to +80 °C where exposure is only occasional (steam cleaning etc.).		
	*No simultaneous chemical and r	nechanical exposure and only in combination	with Sikafloor® systems as a
	broadcast system with approx. 3-	4 +1-1-1	

SYSTEM INFORMATION

Sv	c+	^-	n		
5v	ST	er	n۹	•	

Primer:

Low / medium porosity concrete	1–2 x Sikafloor®-161 HC
High porosity concrete	2 x Sikafloor®-161 HC

Levelling mortar fine (surface roughness < 1 mm):

Primer	1–2 x Sikafloor®-161 HC		
Levelling mortar	1 x Sikafloor®-161 HC + quartz sand		
	(0.1–0.3 mm) + Extender T		

Levelling mortar medium (surface roughness up to 2 mm):

Primer	1–2 x Sikafloor®-161 HC
Levelling mortar	1 x Sikafloor®-161 HC + quartz sand
	(0.1–0.3 mm) + Extender T

Intermediate layer (self-smoothing 1.5–3 mm):

Primer	1–2 x Sikafloor®-161 HC
Levelling mortar	1 x Sikafloor®-161 HC + quartz sand
	(0.1–0.3 mm)

Epoxy screed (15-20 mm layer thickness) / repair mortar

Primer	1–2 x Sikafloor®-161 HC	
Bonding bridge	1 x Sikafloor®-161 HC	
Screed	1 x Sikafloor®-161 HC + suitable	
	sand mixture	

In practice the following sand mixtures proved to be suitable (grain size distribution for layer thicknesses of 15–20 mm):

- 25 pbw quartz sand 0.1–0.5 mm
- 25 pbw quartz sand 0.4–0.7 mm
- 25 pbw quartz sand 0.7–1.2 mm
- 25 pbw quartz sand 2–4 mm

Note: The largest grain size should be a maximum 1/3 of the finished layer thickness. Dependent on the grain shape and application temperatures, the aggregates and the most suitable mix should be selected.



APPLICATION INFORMATION

Mixing Ratio	Part A : part B = 79 : 21 (by weight)		
Consumption	Coating System	Product	Consumption
	Priming	Sikafloor®-161 HC	0.35-0.55 kg/m ²
	Levelling mortar fine	1 pbw Sikafloor®-161	1.7 kg/m²/mm
	(surface roughness < 1	HC + 0.5 pbw quartz	
	mm)	sand (0.1–0.3 mm) +	
		0.015 pbw Extender T	
	Levelling mortar medi-	1 pbw Sikafloor®-161	1.9 kg/m²/mm
	um (surface roughness	HC + 1 pbw quartz sand	
	up to 2 mm)	(0.1–0.3 mm) + 0.015 pbw Extender T	
	Intermediate layer	1 pbw Sikafloor®-161	1.9 kg/m² mixture (0.95
	(self-smoothing 1.5–3	HC + 1 pbw quartz sand	· .
	mm)	(0.1–0.3 mm)	kg/m² quartz sand) per
	111111)	+ optional broadcast	mm layer thickness
		quartz sand 0.4–0.7	~4.0 kg/m ²
		mm	
	Bonding bridge	Sikafloor®-161 HC	0.3–0.5 kg/m ²
	Epoxy screed (15–20	1 pbw Sikafloor®-161	2.2 kg/m²/mm
	mm layer thickness) /	HC + 6–8 pbw quartz	
	Repair Mortar	sand	
			ow for any additional ma- ofile, variations in level or
Layer Thickness	•		
Layer Thickness	As Top Coat		min. / 140 microns max.
Layer Thickness	As Top Coat As stand alone coating		min. / 140 microns max. s min. / 275 microns
Layer Thickness Ambient Air Temperature		140 micron max.	
	As stand alone coating	140 micron max.	
Ambient Air Temperature	As stand alone coating +10 °C min. / +30 °C ma	140 micron max.	
Ambient Air Temperature Relative Air Humidity	As stand alone coating +10 °C min. / +30 °C ma 80 % r.h. max. Beware of condensation	140 micron max.	s min. / 275 microns
Ambient Air Temperature Relative Air Humidity	As stand alone coating +10 °C min. / +30 °C ma 80 % r.h. max. Beware of condensation The substrate and uncu	140 micron max.	s min. / 275 microns 3 °C above dew point to
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Ambient Air Temperature Relative Air Humidity Dew Point Substrate Temperature	+10 °C min. / +30 °C ma 80 % r.h. max. Beware of condensation The substrate and uncureduce the risk of condensation Note: Low temperature ility of blooming. +10 °C min. / +30 °C ma < 4 % pbw moisture contest method: Sika®-Trai	n! red floor must be at least ensation or blooming on this and high humidity conding.	s min. / 275 microns 3 °C above dew point to he floor finish. itions increase the probabations in the probabation in the probability i
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Curing Time

Before applying solvent free products on Sikafloor®-161 HC allow:

Substrate Temperature Minimum

+10 °C	24 h	4 d	
+20 °C	12 h	2 d	_
+30 °C	8 h	24 h	
Before applying	solvent containing produ	icts on Sikafloor®-161 HC allow:	:
Substrate Temr	erature Minimum	Maximum	

Substrate Temperature	Minimum	Maximum
+10 °C	36 h	6 d
+20 °C	24 h	4 d
+30 °C	16 h	2 d

Times are approximate and will be affected by changing ambient conditions particularly temperature and relative humidity.

Applied Product Ready for Use

Substrate Temperature	Foot Traffic	Light Traffic	Full Cure
perature			
+10 °C	~24 h	~6 d	~10 d
+20 °C	~12 h	~4 d	~7 d
+30 °C	~8 h	~2 d	~5 d

Note: Times are approximate and will be affected by changing ambient and substrate conditions.

APPLICATION INSTRUCTIONS

SUBSTRATE QUALITY / PRE-TREATMENT

- The concrete substrate must be sound and of sufficient compressive strength (minimum 25 N/mm²) with a minimum pull off strength of 1.5 N/mm².
- The substrate must be clean, dry and free of all contaminants such as dirt, oil, grease, coatings and surface treatments, etc.
- Concrete substrates must be prepared mechanically using abrasive blast cleaning or scarifying equipment to remove cement laitance and achieve an open textured surface.
- High spots must be removed by e.g. grinding.
- Weak concrete must be removed and surface defects such as blowholes and voids must be fully exposed.
- Repairs to the substrate, filling of blowholes/voids and surface levelling must be carried out using appropriate products from the Sikafloor®, SikaDur® and SikaGard® range of materials.
- All dust, loose and friable material must be completely removed from all surfaces before application of the product, preferably by brush and/or vacuum.

MIXING

Prior to mixing, stir part A mechanically. When all of part B has been added to part A, mix continuously for 3 minutes until a uniform mix has been achieved. When parts A and B have been mixed, add the quartz sand and if required the Extender T and mix for a further 2 minutes until a uniform mix has been achieved. To ensure thorough mixing pour materials into another container and mix again to achieve a consistent mix. Over mixing must be avoided to minimise air entrainment.

MIXING TOOLS

Sikafloor®-161 HC must be thoroughly mixed using a low speed electric stirrer (300-400 rpm) or other suitable equipment. For the preparation of mortars use a forced action mixer of rotating pan, paddle or trough type. Free fall mixers should not be used.

Maximum

APPLICATION

Prior to application, confirm substrate moisture content, r.h. and dew point.

If > 4 % pbw moisture content, Sikafloor® EpoCem® may be applied as a T.M.B. (temporary moisture barrier) system.

Primer

Make sure that a continuous, pore free coat covers the substrate. If necessary, apply two priming coats. Apply Sikafloor®-161 HC by brush, roller or squeegee.

Levelling mortar

Rough surfaces need to be levelled first. Apply the levelling mortar by squeegee/trowel to the required thickness.

Intermediate layer

Sikafloor®-161 HC is poured, spread evenly by means of a serrated trowel. Roll immediately in two directions with spiked roller to ensure even thickness and if required broadcast with quartz sand, after about 15 minutes (at +20 °C) but before 30 minutes (at +20 °C), at first lightly and then to excess.

Bonding bridge

Apply Sikafloor®-161 HC by brush, roller or squeegee. Preferred application is by using a squeegee and then backrolling crosswise.

Epoxy screed / repair mortar

Apply the mortar screed evenly on the still "tacky" bonding bridge, using leveling battens and screed rails as necessary. After a short waiting time compact and smoothen the mortar with a trowel or Teflon coated power float (usually 20–90 rpm).

CLEANING OF TOOLS

Clean all tools and application equipment with Thinner C immediately after use. Hardened / cured material can only be mechanically removed.



IMPORTANT CONSIDERATIONS

- Do not apply Sikafloor®-161 HC on substrates with rising moisture.
- Freshly applied Sikafloor®-161 HC should be protected from damp, condensation and water for at least 24 hours.
- Avoid puddles on the surface with the primer.
- Sikafloor®-161 HC mortar screed is not suitable for frequent or permanent contact with water unless sealed.
- Practical trials should be carried out for mortar mixes to assess suitable aggregate grain size distribution.
- For external applications, apply on a falling temperature. If applied during rising temperatures "pin holing" may occur from rising air.
- These pinholes can be closed after a soft grinding by applying a scratch coat of Sikafloor®-161 HC mixed with approx. 3 % of Extender T.

Construction joints require pre-treatment. Treat as follows:

- Static Cracks: prefill and level with SikaDur® or Sikafloor® epoxy resin
- Dynamic cracks: to be assessed and if necessary apply a stripe coat of elastomeric material or design as a movement joint

The incorrect assessment and treatment of cracks may lead to a reduced service life and reflective cracking. Under certain conditions, underfloor heating or high ambient temperatures combined with high point loading, may lead to imprints in the resin. If heating is required do not use gas, oil, paraffin or other fossil fuel heaters, these produce large quantities of both CO2 and H2O water vapour, which may adversely affect the finish. For heating use only electric powered warm air blower systems.

BASIS OF PRODUCT DATA

All technical data stated in this Product Data Sheet are based on laboratory tests. Actual measured data may vary due to circumstances beyond our control.

LOCAL RESTRICTIONS

Please note that as a result of specific local regulations the performance of this product may vary from country to country. Please consult the local Product Data Sheet for the exact description of the application fields.

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ECOLOGY, HEALTH AND SAFETY

For information and advice on the safe handling, storage and disposal of chemical products, users shall refer to the most recent Safety Data Sheet (SDS) containing physical, ecological, toxicological and other safety-related data.

LEGAL NOTES

The information, and, in particular, the recommendations relating to the application and end-use of Sika products, are given in good faith based on Sika's current knowledge and experience of the products when properly stored, handled and applied under normal conditions in accordance with Sika's recommendations. In practice, the differences in materials, substrates and actual site conditions are such that no warranty in respect of merchantability or of fitness for a particular purpose, nor any liability arising out of any legal relationship whatsoever, can be inferred either from this information, or from any written recommendations, or from any other advice offered. The user of the product must test the product's suitability for the intended application and purpose. Sika reserves the right to change the properties of its products. The proprietary rights of third parties must be observed. All orders are accepted subject to our current terms of sale and delivery. Users must always refer to the most recent issue of the local Product Data Sheet for the product concerned, copies of which will be supplied on request.

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